

NCE N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

The NCE3050K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

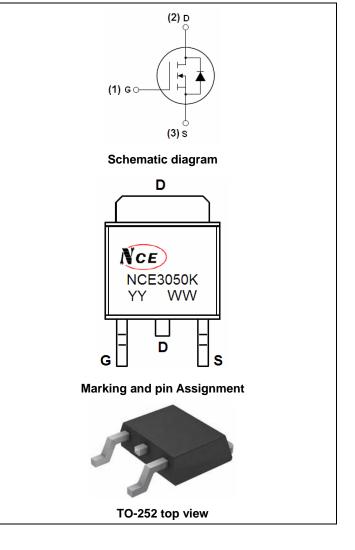
GENERAL FEATURES

- V_{DS} =30V,I_D =50A
 R_{DS(ON)} < 9mΩ @ V_{GS}=10V
 R_{DS(ON)} < 15mΩ @ V_{GS}=5V
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

100% UIS TESTED!



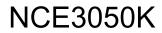
Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3050K	NCE3050K	TO-252	-	-	-

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	50	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	35	A
Pulsed Drain Current	I _{DM}	140	A
Maximum Power Dissipation	PD	60	W
Derating factor		0.4	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	70	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C





Thermal Characteristic

Thermal Resistance, Junction-to-Case(Note 2)	R _{θJC}	2.5	°C/W	
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics			•				
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30			V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V			1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA	
On Characteristics (Note 3)			•				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1		3	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =25A			9	9 15 mΩ	
		V _{GS} =5V, I _D =20A			15		
Forward Transconductance	g fs	V _{DS} =10V,I _D =20A	15			S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}			2000		PF	
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz		280		PF	
Reverse Transfer Capacitance	C _{rss}			160		PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}			10		nS	
Turn-on Rise Time	tr	V _{DD} =15V,I _D =20A		8		nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =1.8 Ω		30		nS	
Turn-Off Fall Time	t _f			5		nS	
Total Gate Charge	Qg)/ -10)// -254		23		nC	
Gate-Source Charge	Q _{gs}	V _{DS} =10V,I _D =25A, V _{GS} =10V		7		nC	
Gate-Drain Charge	Q _{gd}	V GS-10 V		4.5		nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =25A		0.85	1.2	V	
Diode Forward Current (Note 2)	ls				40	Α	
Reverse Recovery Time	trr	TJ = 25°C, IF = 40A 22		22	35	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3)		12	20	nC	
		Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

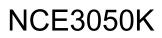
4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ\!\mathrm{C}$,V_DD=15V,V_G=10V,L=1mH,Rg=25\Omega



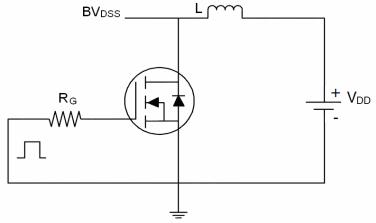
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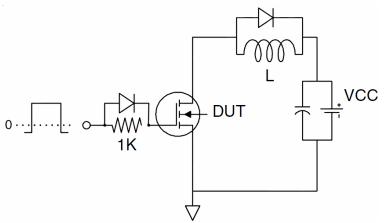


Test circuit

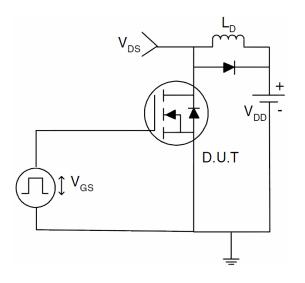
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:

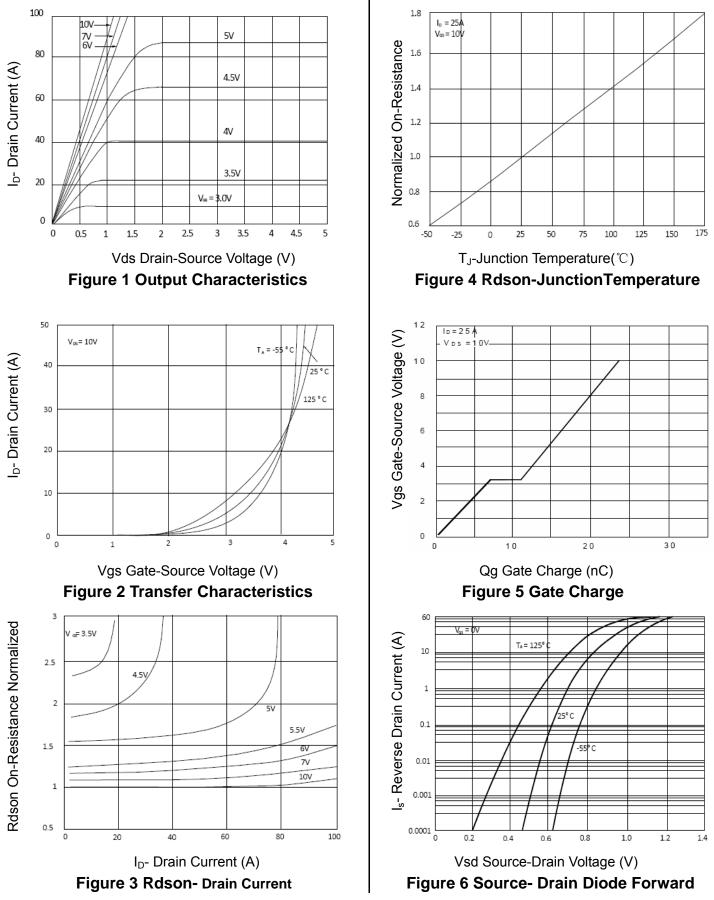


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NCE3050K

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

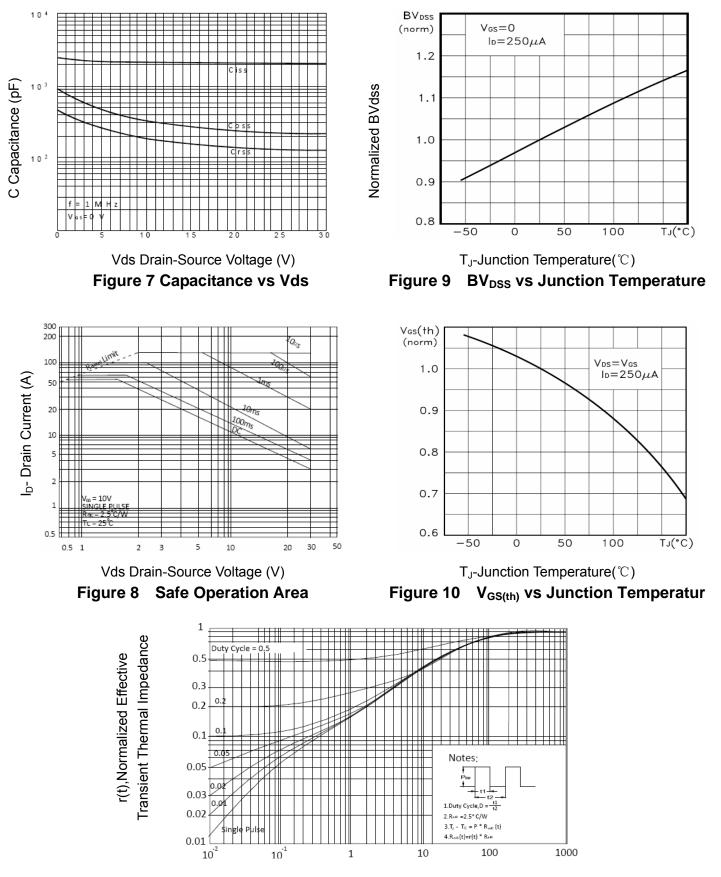




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NCE3050K

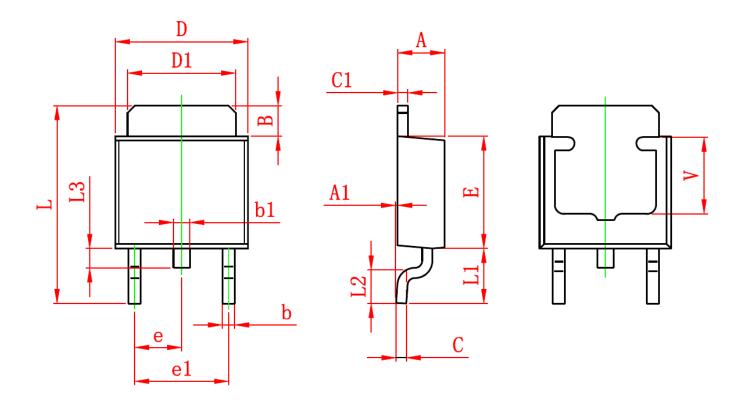


Square Wave Pluse Duration(sec)
Figure 11 Normalized Maximum Transient Thermal Impedance

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TO-252-2L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
С	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
E	5.400	5.700	0.213	0.224	
е	2.300 TYP.		0.091	TYP.	
e1	4.500	4.700	0.177	0.185	
L	9.500	9.900	0.374	0.390	
L1	2.550	2.900	0.100	0.114	
L2	1.400	1.780	0.055	0.070	
L3	0.600	0.900	0.024	0.035	
V	3.800	REF.	0.150 REF.		



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